FORM PTO-1595 (Rev. 6-93)



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VER SHEET

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To the Commissioner for Patents	Attorney Docket No.: 054216-5013
Please record the attached original documents or copy ther	eof. ATTN: BOX ASSIGNMENT
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):
Ga Won LEE 3-27-02	Name: Hynix Semiconductor Inc.
Additional names of conveying party(ies) attached? [] Yes [X] No	Internal Address:
3. Nature of conveyance:	Street Address: San 136-1, Ami-Ri, Bubal-Uep, Ichon-Shi, Kyungki-Do, Republic of Korea City: State: Zip:
[X] Assignment [] Merger [] Security Agreement [] Change of Name [] Other	Additional name(s) & address(es) attached?
Evenution Data: February 16, 2002	[]Yes [X] No
Execution Date: <u>February 16, 2002</u> 4. New Application number(s) or patent number(s):	
4. New Application number(s) or patent number(s): If this document is being filed together with a new applicat A. Patent Application No.(s) 10/026,956 Additional numbers attached: [] Yes [] No	ion the execution date of the application is: B. Patent No.(s)
 4. New Application number(s) or patent number(s): If this document is being filed together with a new applicat A. Patent Application No.(s) 10/026,956 	
4. New Application number(s) or patent number(s): If this document is being filed together with a new applicat A. Patent Application No.(s) 10/026,956 Additional numbers attached: [] Yes [] No 5. Name and address of party to whom correspondence	B. Patent No.(s) 6. Total number of applications and patents involved: 1 7. Total fee (37 C.F.R. §3.41): _\$40.00 [] Enclosed [X] Authorized to be charged to Deposit Account 50-0310 8. Deposit Account No. 50-0310
 New Application number(s) or patent number(s): If this document is being filed together with a new applicat A. Patent Application No.(s) 10/026,956 Additional numbers attached: [] Yes [] No Name and address of party to whom correspondence concerning document should be mailed: Name: Robert J. Gaybrick Internal Address: Morgan, Lewis & Bockius LLP 	B. Patent No.(s) 6. Total number of applications and patents involved: 1 7. Total fee (37 C.F.R. §3.41): _\$40.00 [] Enclosed [X] Authorized to be charged to Deposit Account 50-0310

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1-WA/1767573.1

PATENT REEL: 012736 FRAME: 0417

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

METHOD OF MANUFACTURING THIN FILM TRANSISTOR IN SEMICONDUCTOR DEVICE

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on December 27, 2001, (Application No. 10/026, 956); and

WHEREAS, **Hynix Semiconductor Inc.**, a corporation of **Republic of Korea**, whose post office address is **San 136-1**, **Ami-Ri**, **Bubal-Uep**, **Ichon-Shi**, **Kyungki-Do**, **Republic of Korea** (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. 10/026, 956), filed December 27, 2001) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s):

RECORDED: 03/27/2002

Full Name of Sole or First Assignor	Assignor's Signature	Date	
LEE, Ga Won	ignes	February 16, 2002	
Address		Citizenship	
Hyundai Apt. 601-1602, Sadong-Ri, Daewol-Myun, Ichon-Shi,		Republic of Korea	
Kyungki-Do, Republic of Korea			
Names of additional inventors attached [] Yes [X] No			
Names of ac	The state of the s		
Full Name of Second Assignor	Assignor's Signature	Date	
Address		Citizenship	
Names of additional inventors attached [] Yes [] No			

PATENT REEL: 012736 FRAME: 0418